

## **Description**

The VSM3407AY uses advanced trench technology to provide excellent  $R_{DS(ON)}$ , This device is suitable for use as a load switch or in PWM applications.

### **General Features**

•  $V_{DS} = -30V, I_{D} = -4.3A$ 

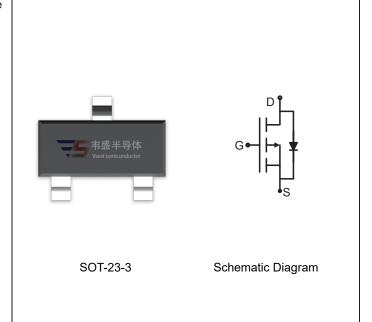
 $R_{DS(ON)} < 90 \text{m}\Omega$  @  $V_{GS}$ =-4.5V

 $R_{DS(ON)}$  <52m $\Omega$  @  $V_{GS}$ =-10V

- High power and current handing capability
- Lead free product is acquired
- Surface mount package

## **Application**

- PWM applications
- Load switch
- Power management



# **Package Marking and Ordering Information**

	Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
Ī	VSM3407AY-S2	VSM3407AY	SOT-23-3	Ø180mm	8 mm	3000 units

Absolute Maximum Ratings (T<sub>A</sub>=25 ℃unless otherwise noted)

Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	VDS	-30	V	
Gate-Source Voltage	V <sub>G</sub> s	±20	V	
Drain Current-Continuous	I <sub>D</sub>	-4.3	Α	
Drain Current-Pulsed (Note 1)	I <sub>DM</sub>	-20	Α	
Maximum Power Dissipation	P <sub>D</sub>	1.5	W	
Operating Junction and Storage Temperature Range	T <sub>J</sub> ,T <sub>STG</sub>	-55 To 150	℃	

#### **Thermal Characteristic**

Thermal Resistance, Junction-to-Ambient (Note 2)	R <sub>0JA</sub>	84	°C/W
,			

# **Electrical Characteristics (T<sub>A</sub>=25**°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit		
Off Characteristics								
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =-250μA	-30	-33	-	V		
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =-24V,V <sub>GS</sub> =0V	-	-	-1	μΑ		



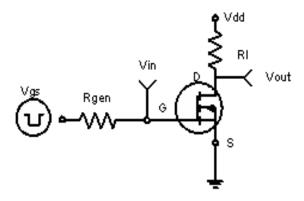
Parameter	Symbol	Condition	Min	Тур	Max	Unit			
Gate-Body Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±20V,V <sub>DS</sub> =0V	-	-	±100	nA			
On Characteristics (Note 3)									
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> ,I <sub>D</sub> =-250μA	-1.1	-1.5	-2.1	V			
Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =-10V, I <sub>D</sub> =-4 A	-	40	52	mΩ			
Drain-Source On-State Resistance		V <sub>GS</sub> =-4.5V, I <sub>D</sub> =-3A	-	48	90	mΩ			
Forward Transconductance	<b>g</b> FS	V <sub>DS</sub> =-5V,I <sub>D</sub> =-1A	-	10	-	S			
Dynamic Characteristics (Note4)	Dynamic Characteristics (Note4)								
Input Capacitance	C <sub>lss</sub>	- V <sub>DS</sub> =-15V,V <sub>GS</sub> =0V, - F=1.0MHz	-	700	-	PF			
Output Capacitance	C <sub>oss</sub>		-	120	-	PF			
Reverse Transfer Capacitance	C <sub>rss</sub>	F-1.UIVITZ	-	75	-	PF			
Switching Characteristics (Note 4)	Switching Characteristics (Note 4)								
Turn-on Delay Time	t <sub>d(on)</sub>		-	9	-	nS			
Turn-on Rise Time	t <sub>r</sub>	$V_{DD}$ =-15V,R <sub>L</sub> =3.6 $\Omega$	-	5	-	nS			
Turn-Off Delay Time	t <sub>d(off)</sub>	$V_{GS}$ =-10 $V$ , $R_{GEN}$ =3 $\Omega$	-	28	-	nS			
Turn-Off Fall Time	t <sub>f</sub>		-	13.5	-	nS			
Total Gate Charge	Qg		-	14	-	nC			
Gate-Source Charge	Q <sub>gs</sub>	V <sub>DS</sub> =-15V,I <sub>D</sub> =-4A,V <sub>GS</sub> =-10V	-	3.1	-	nC			
Gate-Drain Charge	$Q_{gd}$		-	3	-	nC			
Drain-Source Diode Characteristics									
Diode Forward Voltage (Note 3)	V <sub>SD</sub>	V <sub>GS</sub> =0V,I <sub>S</sub> =-4.3A	-	-	-1.2	V			

## Notes:

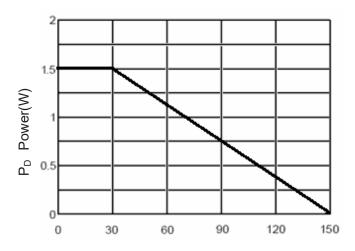
- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- **2.** Surface Mounted on FR4 Board,  $t \le 10$  sec.
- 3. Pulse Test: Pulse Width  $\leq$  300 $\mu$ s, Duty Cycle  $\leq$  2%.
- 4. Guaranteed by design, not subject to production



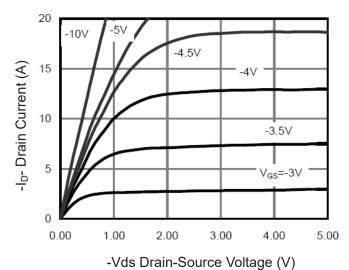
# **Typical Electrical and Thermal Characteristics**



**Figure 1:Switching Test Circuit** 



 $T_J$ -Junction Temperature (°C) Figure 3 Power Dissipation



**Figure 5 Output Characteristics** 

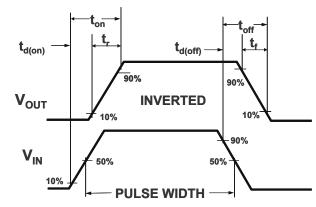
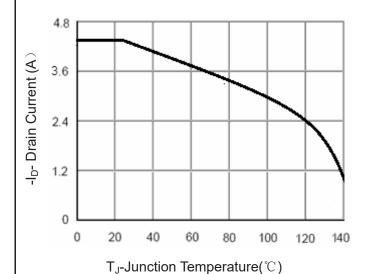


Figure 2:Switching Waveforms



**Figure 4 Drain Current** 

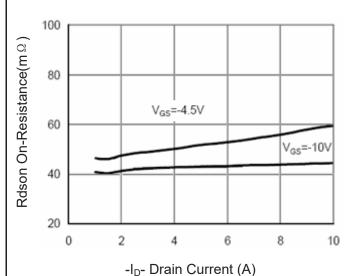


Figure 6 Drain-Source On-Resistance



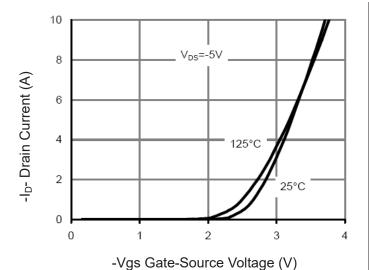
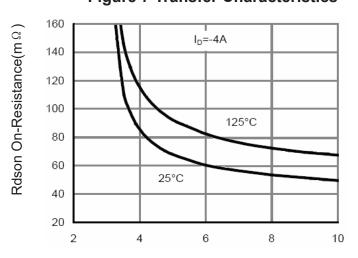


Figure 7 Transfer Characteristics



-Vgs Gate-Source Voltage (V)

Figure 9 Rdson vs Vgs

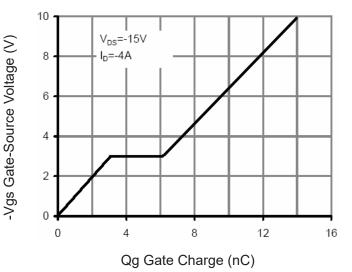


Figure 11 Gate Charge

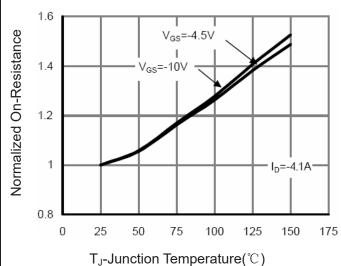
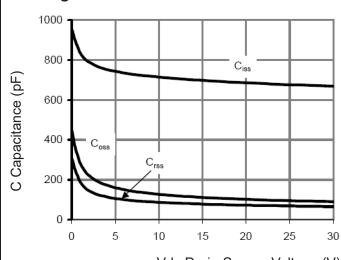


Figure 8 Drain-Source On-Resistance



-Vds Drain-Source Voltage (V)

Figure 10 Capacitance vs Vds

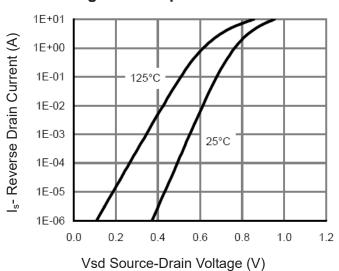
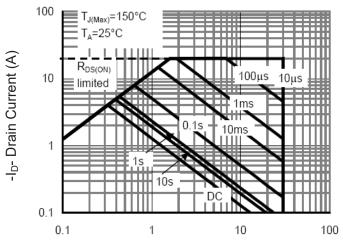


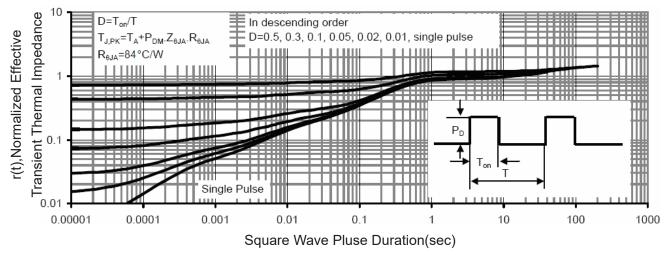
Figure 12 Source- Drain Diode Forward





-Vds Drain-Source Voltage (V)

Figure 13 Safe Operation Area



**Figure 14 Normalized Maximum Transient Thermal Impedance**